

MOTOROLA
SEMICONDUCTOR
TECHNICAL DATA

BD795 **BD799**
BD797 **BD801**

**PLASTIC HIGH POWER
SILICON NPN TRANSISTOR**

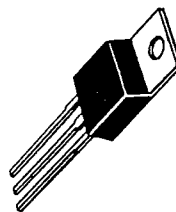
... designed for use up to 30 Watt audio amplifiers utilizing complementary or quasi complementary circuits.

- DC Current Gain— $h_{FE} = 40$ (Min) @ $I_C = 1.0$ Adc
- BD 795, 797, 799, 801 are complementary with BD 796, 798, 800, 802

**8 AMPERE
POWER TRANSISTOR**
NPN SILICON
45, 60, 80, 100 VOLTS
65 WATTS

MAXIMUM RATINGS

Rating	Symbol	Type	Value	Unit
Collector-Emitter Voltage	V_{CEO}	BD795 BD797 BD799 BD801	45 60 80 100	Vdc
Collector-Base Voltage	V_{CBO}	BD795 BD797 BD799 BD801	45 60 80 100	Vdc
Emitter-Base Voltage	V_{EBO}		5	Vdc
Collector Current	I_C		8	Adc
Base Current	I_B		3	Adc
Total Device Dissipation Derate above 25°C	P_D		65 522	Watts mW/°C
Operating and Storage Junction Temperature Range	T_J, T_{stg}		-55 to +150	°C



THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	θ_{JC}	1.92	°C/W

ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Type	Min	Max	Unit
Collector-Emitter Sustaining Voltage* ($I_C = 0.1$ Adc, $I_B = 0$) ($I_C = 0.05$ Adc, $I_B = 0$)	BV_{CEO}	BD795 BD797 BD799 BD801	45 60 80 100	—	Vdc
Collector Cutoff Current ($V_{CB} = 45$ Vdc, $I_E = 0$) ($V_{CB} = 60$ Vdc, $I_E = 0$) ($V_{CB} = 80$ Vdc, $I_E = 0$) ($V_{CB} = 100$ Vdc, $I_E = 0$)	I_{CBO}	BD795 BD797 BD799 BD801	—	0.1 0.1 0.1 0.1	mAdc
Emitter Cutoff Current ($V_{BE} = 5.0$ Vdc, $I_C = 0$)	I_{EBO}		—	10	mAdc
DC current Gain ($I_C = 1$ A, $V_{CE} = 2$ V) ($I_C = 3$ A, $V_{CE} = 2$ V)	h_{FE}	BD 795/797 BD 799/801 BD 795/797 BD 799/801	40 30 25 15	—	
Collector-Emitter Saturation Voltage* ($I_C = 3$ Adc, $I_B = 0.3$ Adc)	$V_{CE(sat)}$		—	10	Vdc
Base-Emitter On Voltage* ($I_C = 3$ Adc, $V_{CE} = 2.0$ Vdc)	$V_{BE(on)}$		—	16	Vdc
Current-Gain-Bandwidth Product ($I_C = 0.25$ Adc, $V_{CE} = 10$ Vdc, $f = 10$ MHz)	f_T		3.0	—	MHz

* Pulse Test Pulse Width $\leq 300 \mu\text{s}$ Duty Cycle $\leq 2.0\%$.

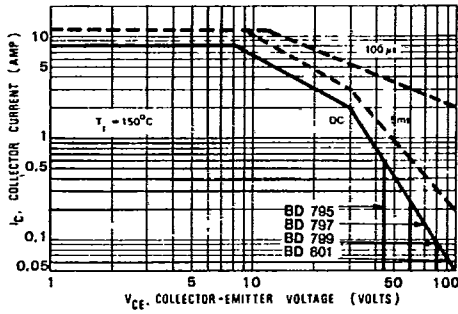
NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIM Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	14.48	15.75	0.570	0.620
B	9.50	10.76	0.370	0.425
C	4.07	4.82	0.160	0.190
D	0.64	0.88	0.025	0.035
F	3.61	3.73	0.142	0.147
G	2.42	2.68	0.095	0.105
H	2.80	2.93	0.110	0.115
J	0.48	0.71	0.018	0.028
K	12.70	14.27	0.500	0.562
L	1.15	1.39	0.045	0.055
N	4.83	5.33	0.190	0.210
Q	7.54	3.04	0.100	0.120
R	2.04	2.79	0.080	0.110
S	1.15	1.39	0.045	0.055
T	5.97	6.47	0.235	0.255
U	0.00	1.27	0.000	0.050
V	1.15	—	0.045	—
Z	—	2.04	—	0.080

STYLE 1:
PIN 1: BASE
2: COLLECTOR
3: EMITTER
4: COLLECTOR

CASE 221A-04
TO-220AB

FIGURE 1 - ACTIVE REGION SAFE OPERATING AREA



The Safe Operating Area Curves indicate I_C - V_{CE} limits below which the device will not enter secondary breakdown. Collector load lines for specific circuits must fall within the applicable Safe Area to avoid causing a catastrophic failure. To insure operation below the maximum T_J , power-temperature derating must be observed for both steady state and pulse power conditions.

FIGURE 2 - COLLECTOR SATURATION REGION

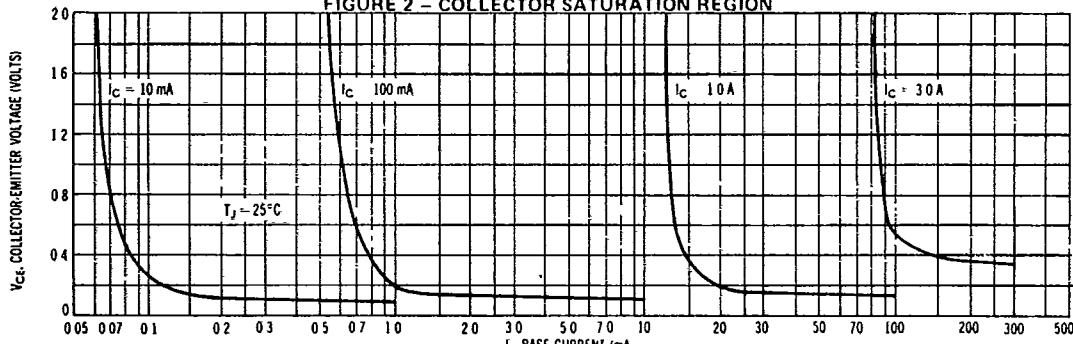


FIGURE 3 - NORMALIZED DC CURRENT GAIN

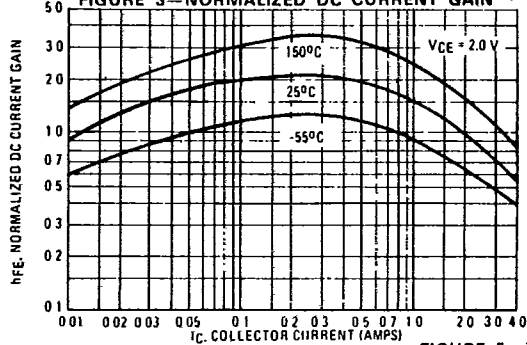


FIGURE 4 "ON" VOLTAGE

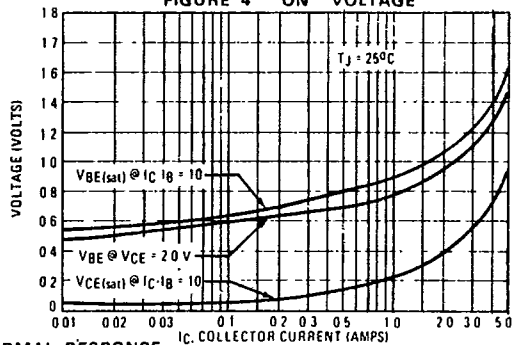
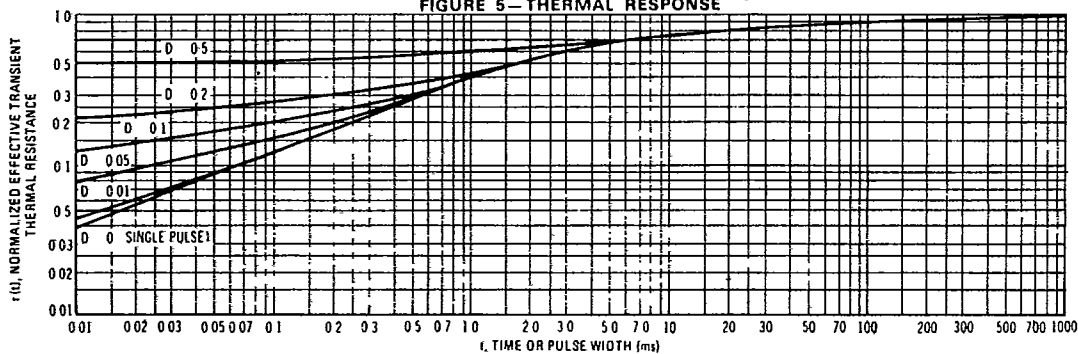


FIGURE 5 - THERMAL RESPONSE



3